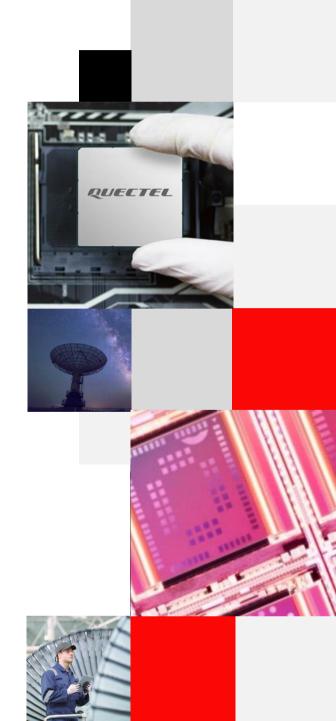




# **Duty of Confidentiality**

The Receiving Party shall keep confidential all documentation and information provided by Quectel, except when the specific permission has been granted by Quectel. The Receiving Party shall not access or use Quectel's documentation and information for any purpose except as expressly provided herein. Furthermore, the Receiving Party shall not disclose any of the Quectel's documentation and information to any third party without the prior written consent by Quectel. For any noncompliance to the above requirements, unauthorized use, or other illegal or malicious use of the documentation and information, Quectel will reserve the right to take legal action.







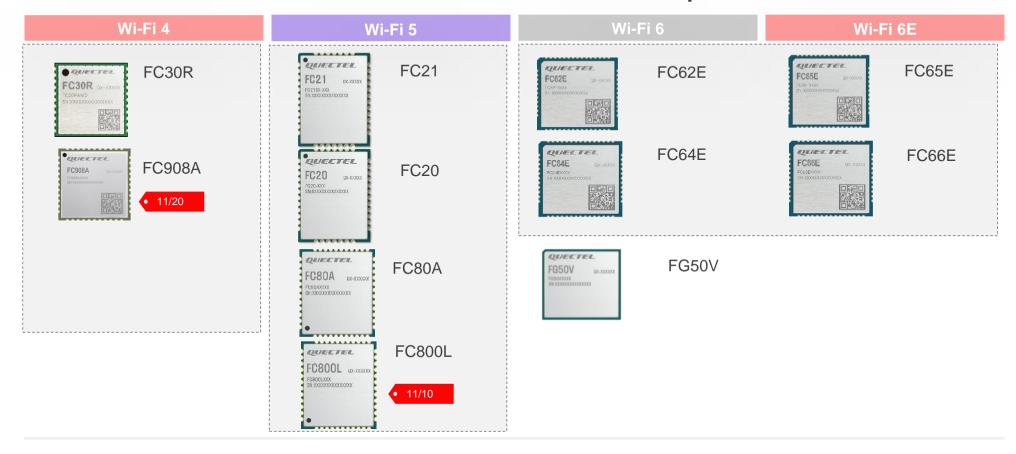
# Roadmap

Product Introduction Technical Architecture Applications QUECTEL

# Non-Automotive Wi-Fi&Bluetooth Modules Roadmap



Hosted Wi-Fi



Stand-alone



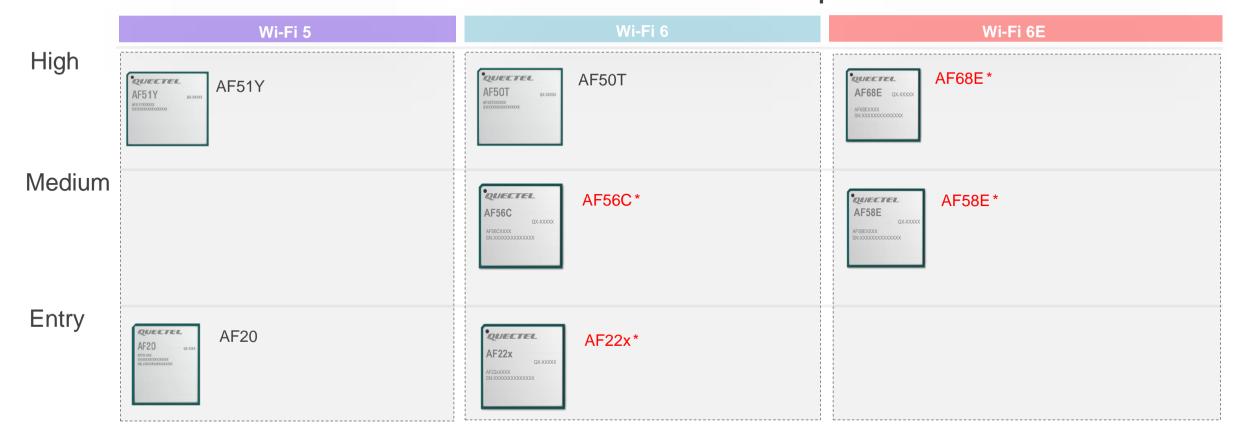
FC41D



HC06U

# Automotive Wi-Fi&Bluetooth Modules Roadmap





Bluetooth



AH20C



Roadmap

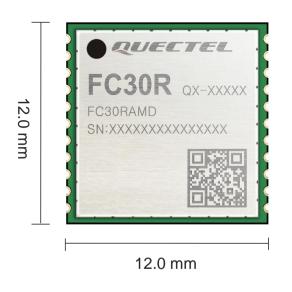
# **Product Introduction**

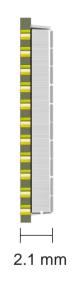
Technical Architecture Applications QUECTEL

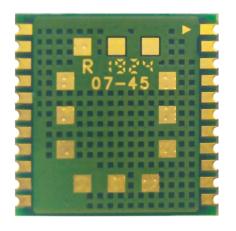


# FC30R Highlights (Wi-Fi 4)

#### Industrial Grade Wi-Fi Module (RTL8189EM)







Length: 12.0 mm ( $\pm$ 0.15 mm) Width: 12.0 mm ( $\pm$ 0.15 mm) Height: 2.1 mm ( $\pm$ 0.20 mm)

Weight: Approx. 0.57 g

- Work with Quectel LTE Standard modules
- Support 802.11 b/g/n, 2.4 GHz band and 1 × 1 antenna
- Cost-effective Wi-Fi only solution
- Operate in soft-AP or station mode
- Operating temperature range: -30 °C to +85 °C
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained solutions

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Module	FC30R						
WLAN Protocol	802.11 b/g/n						
Wi-Fi Bands (GHz)	2.4						
Wi-Fi Modulation	DBPSK, DQPSK, BPSK, QPSK, CCK,16QAM, 64QAM						
Dimension (mm)	12.0 × 12.0 × 2.1						
Working Mode	P/ STA						
Power Supply Voltage Range (V)	3.0–3.6, Typ. 3.3						
Interfaces	SDIO 3.0 × 1, Wi-Fi × 1						
I/O Power Supply Voltage Range (V)	<ul><li>■ 1.75–1.89, Typ.1.8</li><li>■ 3.0–3.6, Typ. 3.3</li></ul>						
Security	TKIP/ AES/ WPA-PSK/ WPA2-PSK						
Operating Temperature Range (°C)	-30 to +85						
Region	Global						
Certification	Regulatory: SRRC/ CE*/ FCC*/ IC*/ Anatel*/ JATE*/ TELEC*/RCM*						

# FC30R Timeline



	2020					2021							
Feb.		Sep.	Oct.	Nov.	Dec.	Jan.		Jul.	Aug.	Sep.	Oct.	Nov.	Dec.

# **Project Stage**



# **Regulatory Certification**

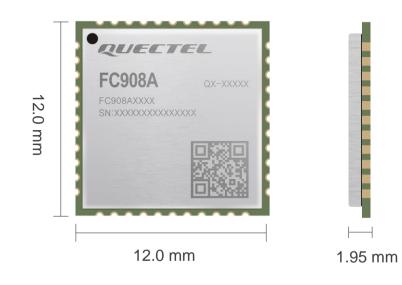


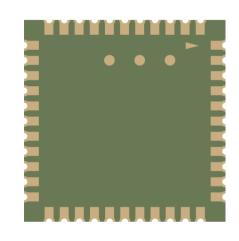
FCC/ IC/ Anatel/ JATE/ TELEC **TBD** 



# FC908A Highlights (Wi-Fi 4)

#### Industrial Grade Wi-Fi&Bluetooth Module (CYW43438)





Length: 12.0 mm ( $\pm$ 0.15 mm) Width: 12.0 mm ( $\pm$ 0.15 mm) Height: 1.95 mm ( $\pm$ 0.20 mm)

Weight: TBD

- Support 802.11 b/g/n, 2.4 GHz band and 1 × 1 antenna
- Operate in soft-AP or station mode, support Bluetooth 5.1
- Operating temperature range: -30 °C to +85 °C
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained solutions

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Module	FC908A
WLAN Protocol	802.11 b/g/n
Wi-Fi Bands (GHz)	2.4
Wi-Fi Modulation	DSSS, OFDM, DBPSK, DQPSK, CCK, BPSK, QPSK,16QAM, 64QAM
Bluetooth Protocol	Bluetooth 5.1
Dimension (mm)	12.0 × 12.0 × 1.95
Working Mode	AP/ STA
Power Supply Voltage Range (V)	3.0–4.8, Typ. 3.6
Interfaces	SDIO 2.0 × 1, Wi-Fi × 1
I/O Power Supply Voltage Range (V)	1.71–3.63, Typ.1.8/3.3
Security	WPA3
Operating Temperature Range (°C)	-30 to +85
Region	Global
Certification	Regulatory: CE*/ FCC*/ SRRC*

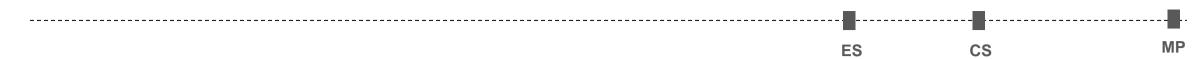
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# FC908A Timeline



					20	21					
Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.

### **Project Schedule**



ES: Engineering samples ready. Basic functions are available for customers' simple demo purpose.

CS: Commercial samples ready. Stable hardware design and quite stable software design. New software features can be added upon request.

MP: Hardware and software ready for mass production. For certification status, please refer to the "certification schedule".

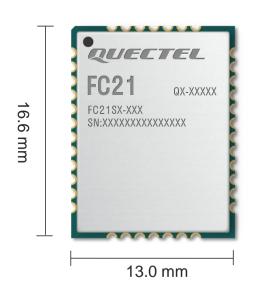
### **Regulatory Certification**

CE/ FCC/ SRRC TBD

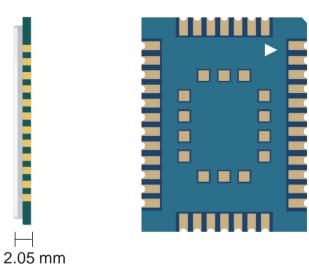


# FC20/FC21 Highlights (Wi-Fi 5)

#### Industrial Grade Wi-Fi&Bluetooth Module (QCA1023/QCA9377)







Length: 16.6 mm ( $\pm$ 0.15 mm) Width: 13.0 mm ( $\pm$ 0.15 mm) Height: 2.05 mm ( $\pm$ 0.20 mm) Weight: Approx. 0.81 g (FC20) Approx. 0.73 g (FC21)

- Based on Qualcomm QCA1023/QCA9377 chipset solution for industrial Wi-Fi and Bluetooth applications
- 1 × 1 device supporting 802.11 a/b/g/n/ac and 2.4/5 GHz dual-band
- 5 GHz power amplifier available to improve Wi-Fi 5 GHz performance for FC20 series, not available for FC21
- Operate in soft-AP or station mode, support Bluetooth 5.0
- Operating temperature range: -40 °C to +85 °C
- Excellent co-existence with Quectel LTE Standard modules
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained solutions

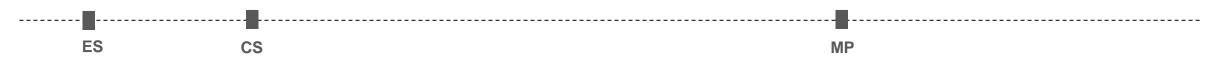
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# FC21 Timeline



2020					2021							2022	
Jun.		Nov.	Dec.	Jan.	Feb.	Mar.		Oct.	Nov.	Dec.	Jan.	Feb.	

### **Project Schedule**



ES: Engineering samples ready. Basic functions are available for customers' simple demo purpose.

CS: Commercial samples ready. Stable hardware design and quite stable software design. New software features can be added upon request.

MP: Hardware and software ready for mass production. For certification status, please refer to the "certification schedule".

#### **Regulatory Certification**

SRRC/ CE/ FCC/ RCM Completed

JATE/ TELEC

Start Complete (Planned)

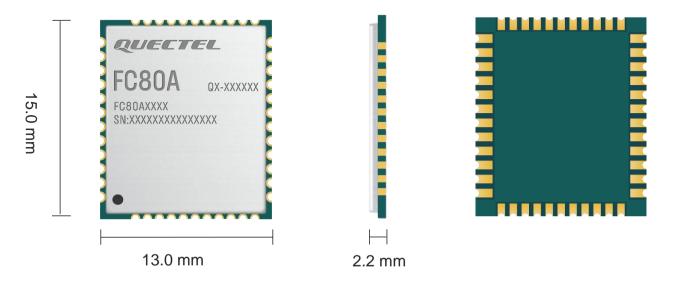
#### **Others**

Bluetooth Completed



# FC80A Highlights (Wi-Fi 5)

#### Industrial Grade Wi-Fi&Bluetooth Module (CYW54591)



Length: 15.0 mm ( $\pm 0.15$  mm) Width: 13.0 mm ( $\pm 0.15$  mm) Height: 2.2 mm ( $\pm 0.20$  mm)

Weight: 0.88 g

- Support 802.11 a/b/g/n/ac and 2.4 GHz/5 GHz dual-band
- Support 2 × 2 MIMO or 1 × 1+ 1 × 1 in RSDB (Real Simultaneous Dual Band) mode
- Operate in soft-AP and station mode, support Bluetooth 5.0
- Operating temperature range: -30 °C to +75 °C
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained solutions

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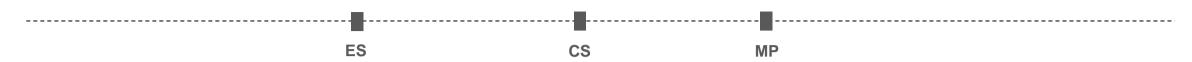
Module	FC80A
WLAN Protocol	802.11 a/b/g/n/ac
Wi-Fi Bands (GHz)	2.4/ 5
Wi-Fi Modulation	BPSK, QPSK, CCK, 16QAM, 64QAM, 256QAM
Bluetooth Protocol	Bluetooth 5.0
Dimension (mm)	15.0 × 13.0 × 2.2
Working Mode	AP/ STA
Interfaces	SDIO 3.0 × 1, UART × 1, PCM × 1, Wi-Fi Antenna × 2, Bluetooth Antenna × 1 (Optional)
Power Supply Voltage Range (V)	VBAT: 3.2–4.5, Typ. 3.3
I/O Power Supply Voltage Range (V)	VDDIO: 1.7–3.6, Typ. 1.8/3.3
Security	WPA3
Max. Physical Data Rate (Mbps)	866.6 Mbps + 300 Mbps, 2 × 2 MIMO, or 1 × 1+ 1 × 1 in RSDB (Real Simultaneous Dual Band) mode
Operating Temperature Range (°C)	-30 to +75
Region	Global
Certification	Regulatory: CE*/ FCC*

# FC80A Timeline



	2021								20	22	
May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.

### **Project Schedule**



ES: Engineering samples ready. Basic functions are available for customers' simple demo purpose.

CS: Commercial samples ready. Stable hardware design and quite stable software design. New software features can be added upon request.

MP: Hardware and software ready for mass production. For certification status, please refer to the "certification schedule".

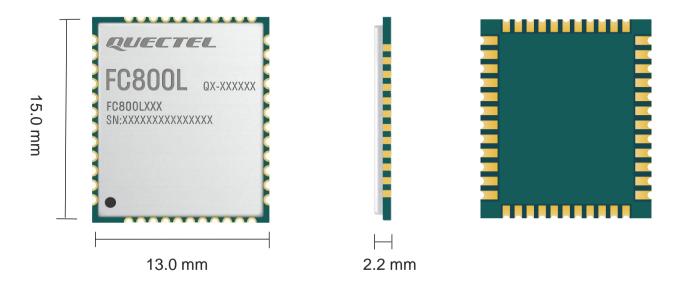
### **Regulatory Certification**

CE/ FCC TBD



# FC800L Highlights (Wi-Fi 5)

#### Industrial Grade Wi-Fi&Bluetooth Module (Amlogic W155S1)



Length: 15.0 mm ( $\pm$ 0.15 mm) Width: 13.0 mm ( $\pm$ 0.15 mm) Height: 2.2 mm ( $\pm$ 0.20 mm)

Weight: TBD

- Support 802.11 a/b/g/n/ac and 2.4 GHz/ 5 GHz dual-band
- Operate in soft-AP and station mode, support Bluetooth 5.0
- Operating temperature range: -30 °C to +85 °C
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained solutions

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Module	FC800L
WLAN Protocol	802.11 a/b/g/n/ac
Wi-Fi Bands (GHz)	2.4/ 5
Wi-Fi Modulation	DSSS, CCK, BPSK, QPSK, DBPSK, DQPSK, 16QAM, 64QAM, 256QAM
Bluetooth Protocol	Bluetooth 5.0
Dimension (mm)	15.0 × 13.0 × 2.2
Working Mode	AP/ STA
Interfaces	SDIO 3.0 × 1, UART × 1, PCM × 1, Wi-Fi × 1, Bluetooth Antenna × 1
Power Supply Voltage Range (V)	VBAT: 2.97–3.63, Typ. 3.3
I/O Power Supply Voltage Range (V)	VDDIO: 1.62–1.98, Typ. 1.8
Security	WPA3
Max. Physical Data Rate (Mbps)	433.3
Operating Temperature Range (°C)	-30 to +85
Region	Global
Certification	Regulatory: CE*/ FCC*/ SRRC*

"\*" means under planning.

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# FC800L Timeline



	2021								2022			
May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.	

# **Project Schedule**



ES: Engineering samples ready. Basic functions are available for customers' simple demo purpose.

CS: Commercial samples ready. Stable hardware design and quite stable software design. New software features can be added upon request.

MP: Hardware and software ready for mass production. For certification status, please refer to the "certification schedule".

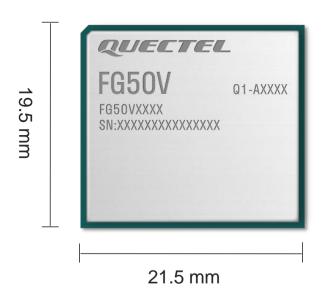
### **Regulatory Certification**

CE/ FCC/ SRRC TBD

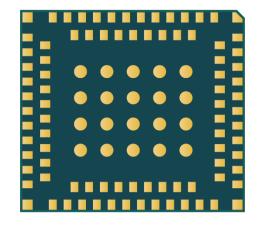


# FG50V Highlights (Wi-Fi 6)

#### Industrial Grade Wi-Fi&Bluetooth Module (QCA6391)







Length: 19.5 mm ( $\pm 0.20$  mm) Width: 21.5 mm ( $\pm 0.20$  mm) Height: 2.1 mm ( $\pm 0.20$  mm)

Weight: 2.3 g

- Must work with Quectel 5G RG50xQ series modules and enjoy good co-existence mechanism
- 2 × 2 + 2 × 2 device supporting 802.11 a/b/g/n/ac/ax and 2.4/ 5 GHz dual-band, with max. data rate up to 1774.5 Mbps
- Operate in soft-AP and station mode, support Bluetooth 5.2
- Operating temperature range: -30 °C to +85 °C
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained solutions

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Module	FG50V
WLAN Protocol	802.11 a/b/g/n/ac/ax
Wi-Fi Bands (GHz)	2.4/5
Wi-Fi Modulation	BPSK, QPSK, CCK, 16QAM, 64QAM, 256QAM, 1024QAM
Bluetooth Protocol	Bluetooth 5.2
Dimension (mm)	19.5 × 21.5 × 2.1
Working Mode	AP/ STA
VBAT	VDD_RF, VDD_CORE_VL, VDD_CORE_VM, VDD_CORE_VH, VDD_IO
Interfaces	PCIe, WLAN_EN, UART, PCM, BT_EN, GPIOs
Security	WPA3
Max. Physical Data Rate (Mbps)	1774.5, 2 × 2 + 2 × 2 MIMO, DBS (Dual Band Simultaneous)
Operating Temperature Range (°C)	-30 to +85
Region	Global
Certification	Regulatory: CE/ FCC/ KC*

"\*" means under ongoing.

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# **FG50V Timeline**



					20	)21					
Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.

### **Project Schedule**



ES: Engineering samples ready. Basic functions are available for customers' simple demo purpose.

CS: Commercial samples ready. Stable hardware design and quite stable software design. New software features can be added upon request.

MP: Hardware and software ready for mass production. For certification status, please refer to the "certification schedule".

### **Regulatory Certification**

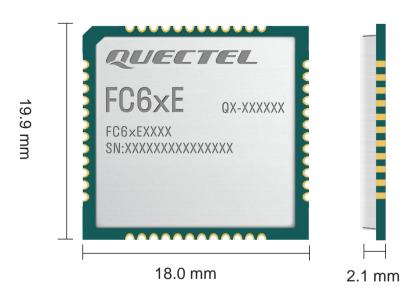


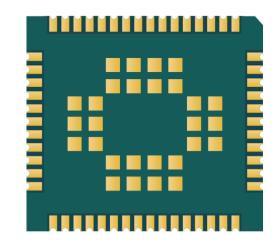
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# FC62E/FC64E Highlights (Wi-Fi 6)

#### Industrial Grade Wi-Fi&Bluetooth Module (QCA2062/QCA2064)





Length: 19.9 mm ( $\pm 0.15$  mm) Width: 18.0 mm ( $\pm 0.15$  mm) Height: 2.1 mm ( $\pm 0.20$  mm)

Weigh: 1.6 g

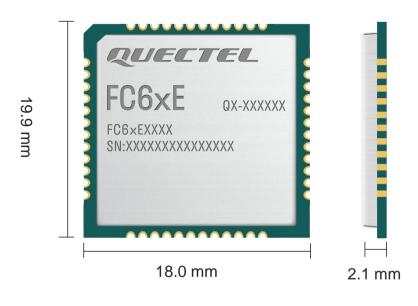
- Support 802.11 a/b/g/n/ac/ax and 2.4/ 5 GHz dual-band, with max. data rate up to 1774.5 Mbps
- Support DBS (Dual Band Simultaneous): FC64E supports DBS, FC62E does not support DBS
- FC64E supports 2 × 2 + 2 × 2 MIMO, FC62E supports 2 × 2 MIMO
- Operate in soft-AP or station mode and support Bluetooth 5.1
- Operating temperature range: -30 °C to +85 °C
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained solutions

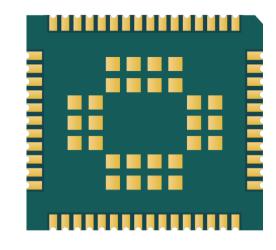
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# FC65E/FC66E Highlights (Wi-Fi 6E)

#### Industrial Grade Wi-Fi&Bluetooth Module (QCA2065/QCA2066)





Length: 19.9 mm ( $\pm 0.15$  mm) Width: 18.0 mm ( $\pm 0.15$  mm) Height: 2.1 mm ( $\pm 0.20$  mm)

Weigh: 1.63 g

- Support 802.11 a/b/g/n/ac/ax and 2.4/ 5/ 6 GHz triple-band, with max. data rate up to 2400 Mbps
- Support DBS (Dual Band Simultaneous): FC66E supports DBS, FC65E does not support DBS
- FC65E supports 2 × 2 MIMO, FC66E supports 2 × 2 + 2 × 2 MIMO
- Operate in soft-AP or station mode and support Bluetooth 5.1
- Operating temperature range: -30 °C to +85 °C
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained solutions

# FC6xE Specifications (Wi-Fi 6 & Wi-Fi 6E)



Module	FC62E/ FC64E	FC65E/ FC66E				
WLAN Protocol	802.11 a/b/g/n/ac/ax	802.11 a/b/g/n/ac/ax				
Wi-Fi Bands (GHz)	2.4/ 5	2.4/ 5/ 6				
Wi-Fi Modulation	DBPSK, DQPSK, CCK, BPSK, QPSK, QAM	DBPSK, DQPSK, CCK, BPSK, QPSK, QAM				
Bluetooth Protocol	Bluetooth 5.1	Bluetooth 5.1				
Dimension (mm)	18.0 × 19.9 × 2.1	18.0 × 19.9 × 2.1				
Working Mode	AP/ STA	AP/ STA				
Power Supply Voltage (V)	0.95, 1.35, 1.95, 1.8, 2.2, 3.3 (Optional)	0.95, 1.35, 1.95, 1.8, 2.2, 3.3 (Optional)				
Interfaces	Wi-Fi: PCle 3.0 × 1 Bluetooth: UART × 1, PCM × 1 Antenna: Wi-Fi × 2, Bluetooth × 1 (shared with Wi-Fi, independent antenna is optional)	Wi-Fi: PCle 3.0 × 1 Bluetooth: UART × 1, PCM × 1 Antenna: Wi-Fi × 2, Bluetooth × 1 (shared with Wi-Fi, independent antenna is optional)				
DBS (Dual Band Simultaneous)	FC62E does not support DBS, FC64E supports DBS	FC65E does not support DBS, FC66E supports DBS				
I/O Power Supply Voltage (V)	1.8	1.8				
Security	WPA3	WPA3				
Operating Temperature Range (°C)	-30 to +85	-30 to +85				
Region	Global	Global				
Certification	Regulatory: CE*/ FCC*/ SRRC*/ JATE*/ TELEC*	Regulatory: CE*/ FCC*/ SRRC*/ JATE*/ TELEC*				

# FC66E/FC65E/FC64E/FC62E Timeline



2021									2022					
Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.

#### **Project Schedule**



ES: Engineering samples ready. Basic functions are available for customers' simple demo purpose.

CS: Commercial samples ready. Stable hardware design and quite stable software design. New software features can be added upon request.

MP: Hardware and software ready for mass production. For certification status, please refer to the "certification schedule".

#### **Regulatory Certification**

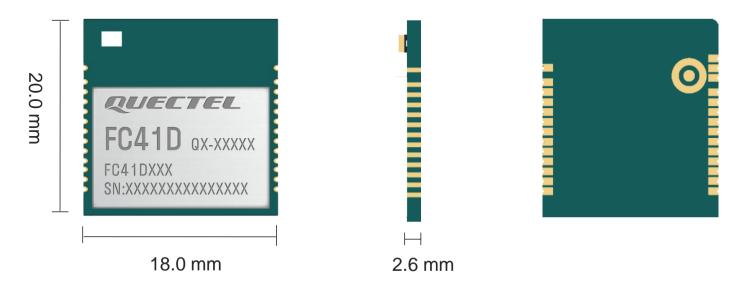
CE/ FCC/ SRRC/ JATE/ TELEC TBD

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# FC41D Highlights

#### Stand-alone Wi-Fi&Bluetooth Module (BK7231M)



Length: 20.0 mm ( $\pm$ 0.20 mm) Width: 18.0 mm ( $\pm$ 0.20 mm) Height: 2.6 mm ( $\pm$ 0.20 mm)

Weight: 1.05 g

- Support 802.11 b/g/n Wi-Fi
- Operate in soft-AP or station mode and support Bluetooth 5.2
- Support UART serial communication
- Compatible with pin antenna, IPEX antenna and PCB antenna
- Operating temperature range: -40 °C to +85 °C
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained automotive solutions

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# FC41D Specifications

Module	FC41D
WLAN Protocol	802.11 b/g/n, 1 x 1
Wi-Fi Bands (GHz)	2.4
Wi-Fi Modulation	BPSK, QPSK, CCK, 16QAM, 64QAM
Bluetooth Protocol	Bluetooth 5.2
Working Mode	AP/ STA
Power Supply Voltage (V)	3.3
Interfaces	UART, SPI, PWM, ADC, GPIOs
Security	WPA3
Operating Temperature Range (°C)	-40 to +85
Region	Global
Certification	Regulatory: CE*/ FCC*/ SRRC* Others: Bluetooth*

# FC41D Timeline



2021									2022		
Mar.	Apr.	May	Jun.	Jul.		Oct.	Nov.	Dec.	Jan.	Feb.	Mar.

### **Project Schedule**



ES: Engineering samples ready. Basic functions are available for customers' simple demo purpose.

CS: Commercial samples ready. Stable hardware design and quite stable software design. New software features can be added upon request.

MP: Hardware and software ready for mass production. For certification status, please refer to the "certification schedule".

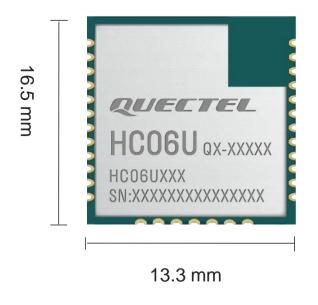
### **Regulatory Certification**



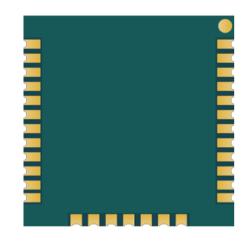


# HC06U Highlights

#### **BLE Module (BR1001)**







Length: 16.5 mm ( $\pm$ 0.20 mm) Width: 13.3 mm ( $\pm$ 0.20 mm) Height: 2.3 mm ( $\pm$ 0.20 mm)

Weight: 0.85 g

- Support Bluetooth 5.0
- High cost performance, BLE module, integrated master and slave mode
- Operating temperature range: -40 °C to +85 °C
- Built-in ceramic antenna, Built-out pin antenna
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained automotive solutions

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# **HC06U Specifications**

Module	HC06U
Bluetooth Protocol	Bluetooth 5.0
Power Supply Voltage (V)	3.3
Interfaces	UART, SPI, GPIOs
Security	SMP
Operating Temperature Range (°C)	-40 to +85
Region	Global
Certification	Regulatory: FCC/ IC/ CE*

# **HC06U Timeline**



2021									2022			
	Jan.	Feb.	Mar.	Apr.	May		Sep.	Oct.	Nov.	Dec.	Jan.	Feb.

### **Project Schedule**



ES: Engineering samples ready. Basic functions are available for customers' simple demo purpose.

CS: Commercial samples ready. Stable hardware design and quite stable software design. New software features can be added upon request.

MP: Hardware and software ready for mass production. For certification status, please refer to the "certification schedule".

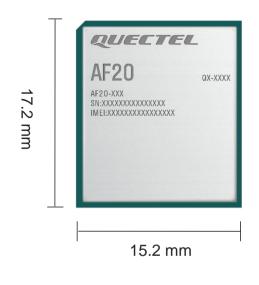
# **Regulatory Certification**



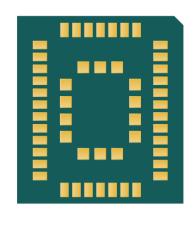


# AF20 Highlights (Wi-Fi 5 1×1)

#### Automotive Grade Wi-Fi&Bluetooth Module (QCA6564A)







Length: 17.2 mm ( $\pm 0.15$  mm) Width: 15.2 mm ( $\pm 0.15$  mm) Height: 2.26 mm ( $\pm 0.20$  mm)

Weight: 1.26 g

- Qualcomm QCA6564A chipset solution dedicated for automotive applications
- Work with Quectel AG35 series module and enjoy good co-existence mechanism with the automotive grade LTE module
- 1 × 1 device supporting 802.11 a/b/g/n/ac and 2.4/ 5 GHz dual-band
- Operate in soft-AP or station mode and support Bluetooth 5.0
- Ideal for automotive applications with IATF 16949 requirement
- Automotive quality processes (PPAP, 8D, DFMEA, PFMEA...)
- Operating temperature range: -40 °C to +85 °C
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained automotive solutions

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# AF20 Specifications (Wi-Fi 5 1×1)

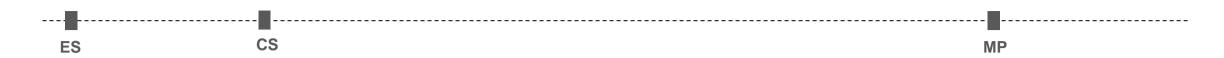
Module	AF20						
Chip	QCA6564A						
WLAN Protocol	802.11 a/b/g/n/ac, 1 × 1						
Wi-Fi Bands (GHz)	.4/ 5						
Wi-Fi Modulation	PSK, QPSK, CCK, 16QAM, 64QAM, 256QAM						
Bluetooth Protocol	luetooth 5.0						
Working Mode	AP/ STA						
Power Supply Voltage Range (V)	3.14–3.46, Typ. 3.3						
Interfaces	SDIO 3.0 × 1, BT_UART × 1, Wi-Fi/Bluetooth Antenna × 1						
I/O Power Supply Voltage Range (V)	1.71–1.89, Typ.1.8						
Security	WEP/ TKIP/ AES/ WPA-PSK/ WPA2-PSK						
Operating Temperature Range (°C)	-40 to +85						
Region	Global						
Certification	Regulatory: CE*/ FCC*/ IC*/ Anatel*/ JATE*/ TELEC*/ RCM*						

# AF20 Timeline



2020				2021								
Jan.		Nov.	Dec.	Jan.		Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	

### **Project Schedule**



ES: Engineering samples ready. Basic functions are available for customers' simple demo purpose.

CS: Commercial samples ready. Stable hardware design and quite stable software design. New software features can be added upon request.

MP: Hardware and software ready for mass production. For certification status, please refer to the "certification schedule".

### **Regulatory Certification**

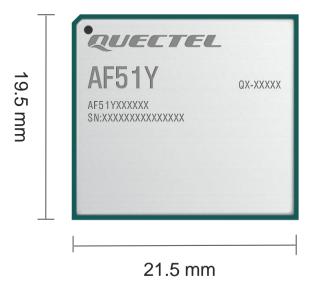


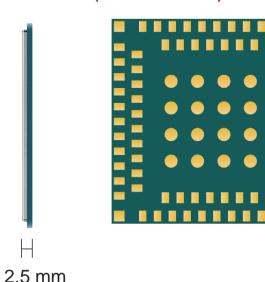
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# AF51Y Highlights (Wi-Fi 5 2×2+1×1)

### Automotive Grade Wi-Fi&Bluetooth Module (QCA6595)





Length: 19.5 mm (±0.20 mm) Width: 21.5 mm (±0.20 mm) Height: 2.5 mm (±0.20 mm) Weight: 2.32 q

- Qualcomm QCA6595 chipset solution dedicated for automotive applications
- Work with Quectel AG55xQ/AG52xR series modules
- Support 802.11 a/b/g/n/ac Wi-Fi and Dual-Band Simultaneous (DBS) with dual-MAC
- Operate in soft-AP and station mode and support Bluetooth 5.2
- Ideal for automotive applications with IATF 16949 requirement
- Automotive quality processes (PPAP, 8D, DFMEA, PFMEA...)
- Operating temperature range: -40 °C to +85 °C
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained automotive solutions

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# AF51Y Specifications (Wi-Fi 5 2×2+1×1)

Module	AF51Y						
Chip	QCA6595						
WLAN Protocol	802.11 a/b/g/n/ac, 2 × 2 + 1 × 1, dual MAC						
Wi-Fi Bands (GHz)	2.4/ 5						
Wi-Fi Modulation	K, BPSK, QPSK,16QAM, 64QAM, 256QAM						
Bluetooth Protocol	uetooth 5.2						
Working Mode	AP/ STA						
Power Supply	/DD_CORE_VL, VDD_CORE_VM, VDD_CORE_VH, VDD_IO						
Interfaces	PCIe, WLAN_EN, UART, PCM, BT_EN, GPIOs						
Security	WPA3						
Operating Temperature Range (°C)	-40 to +85						
Region	Global						
Certification	Regulatory: CE*/ FCC*/ IC*/ Anatel*/ JATE*/ TELEC*						

### **AF51Y Timeline**



2021											
Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.

### **Project Schedule**



ES: Engineering samples ready. Basic functions are available for customers' simple demo purpose.

CS: Commercial samples ready. Stable hardware design and quite stable software design. New software features can be added upon request.

MP: Hardware and software ready for mass production. For certification status, please refer to the "certification schedule".

### **Regulatory Certification**

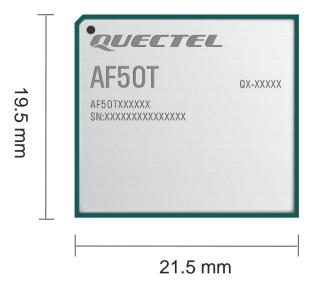
CE/ FCC/ IC/ Anatel/ JATE/ TELEC TBD

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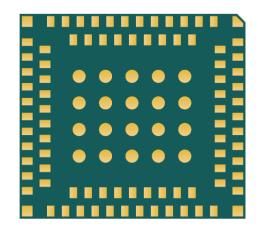


# AF50T Highlights (Wi-Fi 6 $2\times2+2\times2$ )

### Automotive Grade Wi-Fi&Bluetooth Module (QCA6696)







Length: 19.5 mm ( $\pm$ 0.20 mm) Width: 21.5 mm ( $\pm$ 0.20 mm) Height: 2.3 mm ( $\pm$ 0.20 mm)

Weight: Approx. 2.1 g

- Qualcomm QCA6696 chipset solution dedicated for automotive applications
- Work with Quectel AG55xQ/AG52xR series modules
- Support 802.11 a/b/g/n/ac/ax Wi-Fi and Dual-Band Simultaneous (DBS) with dual-MAC
- Operate in soft-AP and station mode and support Bluetooth 5.2
- Ideal for automotive applications with IATF 16949 requirement
- Automotive quality processes (PPAP, 8D, DFMEA, PFMEA...)
- Operating temperature range: -40 °C to +85 °C
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained automotive solutions

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# AF50T Specifications (Wi-Fi 6 2×2+2×2)

Module	AF50T					
Chip	QCA6696					
WLAN Protocol	802.11 a/b/g/n/ac/ax, 2 × 2 + 2 × 2, dual MAC					
Wi-Fi Bands (GHz)	2.4/ 5					
Wi-Fi Modulation	DBPSK, DQPSK, CCK, BPSK, QPSK, QAM, MU-MIMO-OFDMA					
Bluetooth Protocol	uetooth 5.2					
Working Mode	AP/ STA					
Power Supply	VDD_RF, VDD_CORE_VL, VDD_CORE_VM, VDD_CORE_VH, VDD_IO					
Interfaces	PCIe, WLAN_EN, UART, PCM, BT_EN, GPIOs					
Security	WPA3					
Operating Temperature Range (°C)	-40 to +85					
Region	Global					
Certification	Regulatory: CE/ FCC/ RCM/ IC*/ Anatel*/ SRRC*/ JATE*/ TELEC*					

# **AF50T Timeline**



2021											20	22			
Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.

### **Project Stage**



### **Regulatory Certification**

CE/ FCC/ RCM Completed

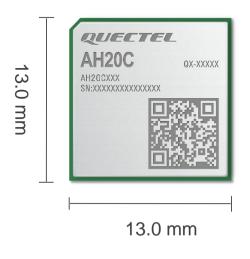
IC/ Anatel/ SRRC/ JATE/ TELEC TBD

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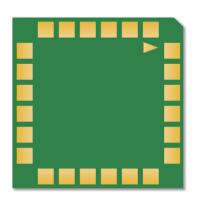


# AH20C Highlights (Stand-alone Bluetooth)

### Automotive Grade Stand-alone Bluetooth Module (CYW89072)







Length: 13.0 mm ( $\pm$ 0.20 mm) Width: 13.0 mm ( $\pm$ 0.20 mm) Height: 2.35 mm ( $\pm$ 0.20 mm)

Weight: TBD

- CYW89072 chipset solution dedicated for automotive applications
- Work with Quectel AG55xQ/AG52xR series modules or third-party platform
- Support Bluetooth 5.0, support BLE and classic Bluetooth
- Ideal for automotive applications with IATF 16949 requirement
- Automotive quality processes (PPAP, 8D, DFMEA, PFMEA...)
- Operating temperature range: -40 °C to +85 °C
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained automotive solutions

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# **AH20C Specifications**

Module	AH20C
Chip	CYW89072
Bluetooth Bands (GHz)	2.4
Bluetooth Modulation	GFSK, π/4-DQPSK, 8-DPSK, Gaussian
Bluetooth Protocol	Bluetooth 5.0 (BLE + Classic Bluetooth)
Bluetooth Profile	HFP, HSP, PBAP, A2DP, AVRCP, MAP, HID, GATT, iAP2, SPP, etc.
Power Supply	VDD_BT_3V3, VDD_IO_1V8
Interfaces	UART, PCM, I2C, BT_HOST_WAKE, BT_DEV_WAKE
Operating Temperature Range (°C)	-40 to +85
Region	Global
Certification	Regulatory: CE*/ FCC*/ IC*

"\*" means under planning.

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### **AH20C Timeline**



2021					2022						
Aug.	Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.	May	Jun.	

### **Project Schedule**



ES: Engineering samples ready. Basic functions are available for customers' simple demo purpose.

CS: Commercial samples ready. Stable hardware design and quite stable software design. New software features can be added upon request.

MP: Hardware and software ready for mass production. For certification status, please refer to the "certification schedule".

### **Regulatory Certification**

CE/ FCC/ IC TBD

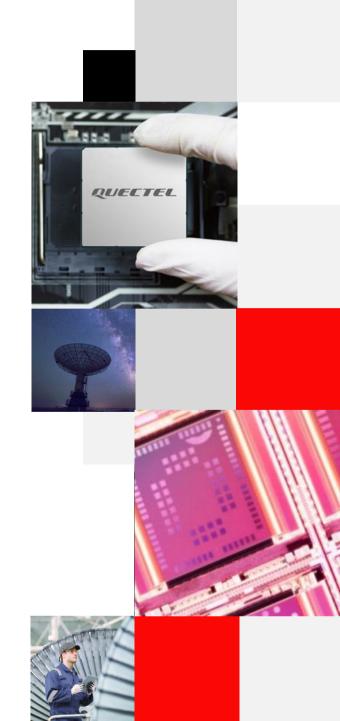
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Roadmap Product Introduction

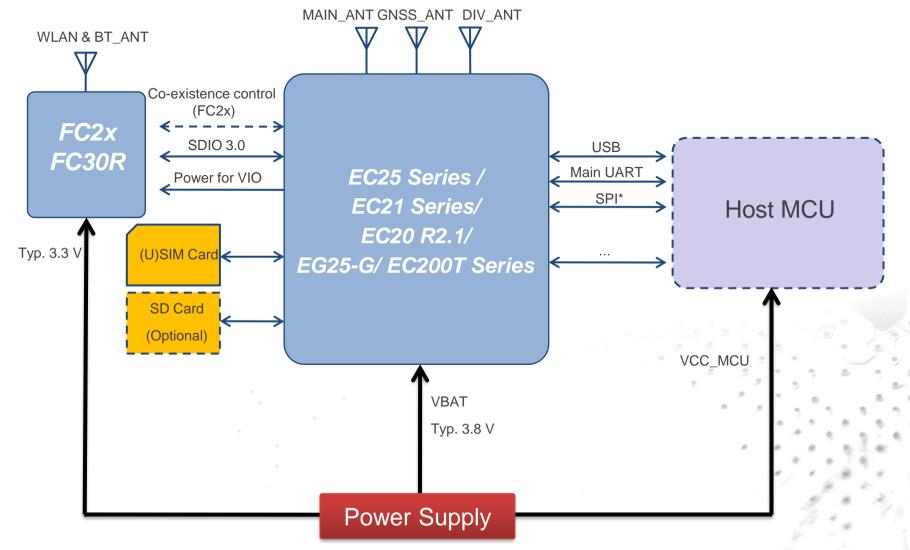
# **Technical Architecture**

**Applications** 



# LTE + FC2x/FC30R Solution



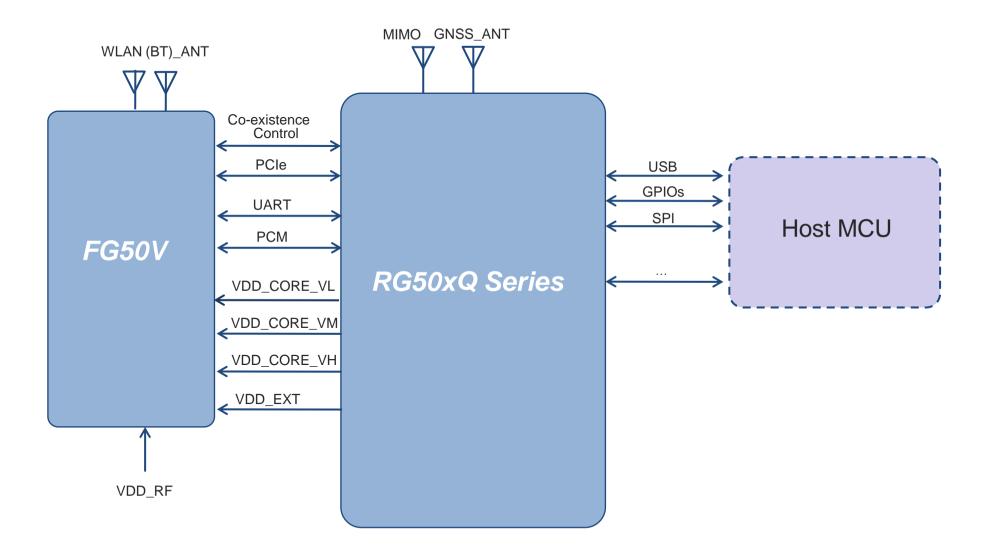


"\*" means under development.

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# RG500Q Series + FG50V Solution

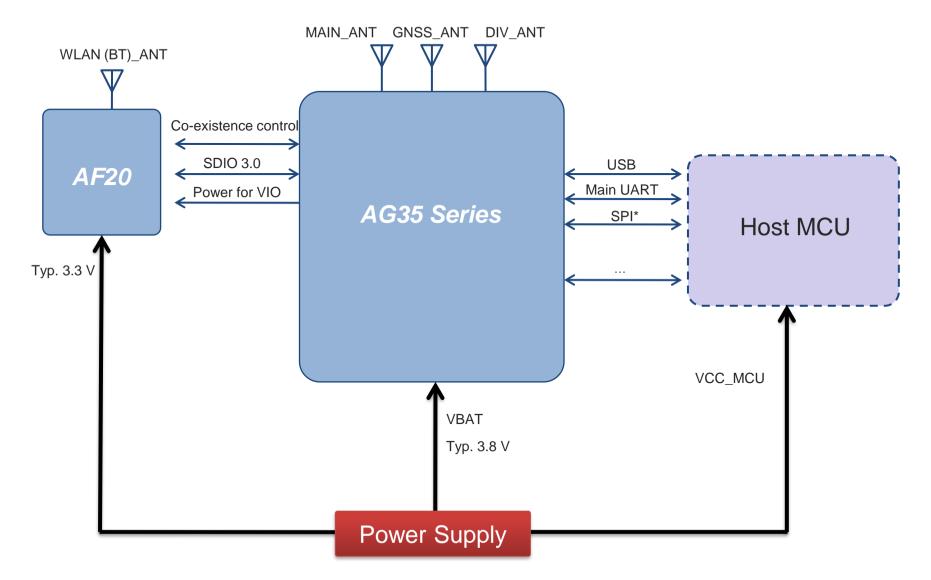




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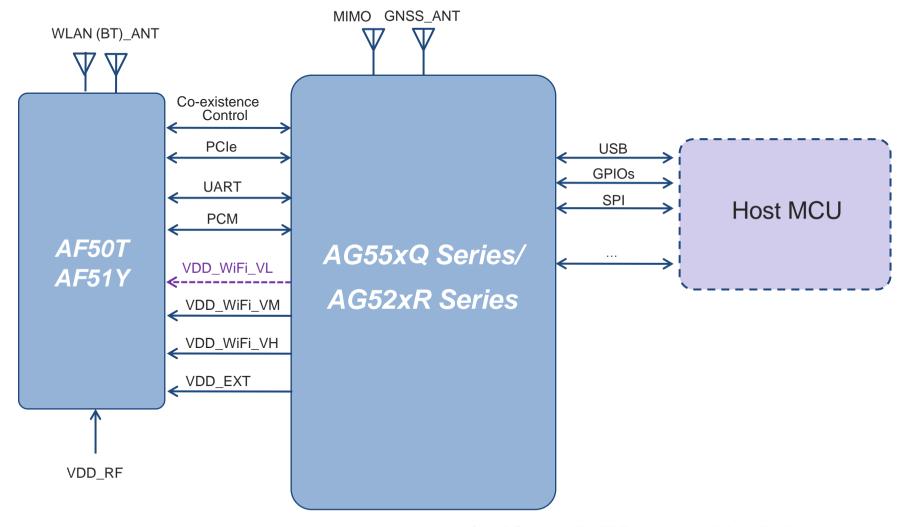








# AG55xQ Series/AG52xR Series + AF50T/AF51Y Solution



In AG52xR Series + AF50T/AF51Y solution, VDD\_WiFi\_VL is inputted by an external DC-DC converter.

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# Wi-Fi&Bluetooth Module Advantages



#### **Best Co-existence**

- The best co-existence of Wi-Fi and LTE/5G
- The best co-existence of Wi-Fi and Bluetooth

### Quality

- Stable and robust network connectivity
- Wide working temperature
- Low power consumption

### **One-stop Solution**

- Used with Quectel cellular modules
- One-stop LTE/5G + Wi-Fi/Bluetooth solution
- Provide the best performance

### **Easy Design**

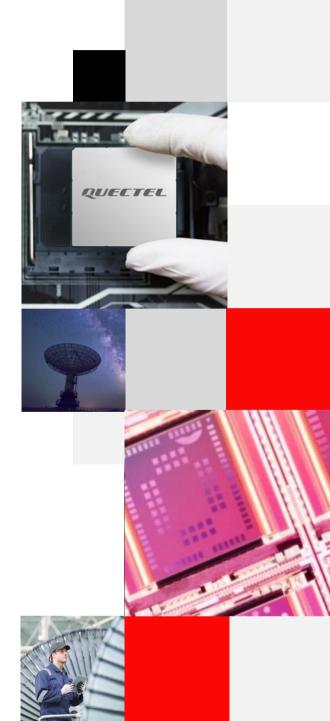
- Compact module package
- Convenient for test
- Convenient for automatic mass production
- Reduce manufacturing cost

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Roadmap
Product Introduction
Technical Architecture

# **Applications**



# **Applications**



### Network

- DTU
- Routers
- Industrial gateway
- Wi-Fi hot spot





### Automotive

- T-box
- Infotainment
- Tracking
- OBD
- DVR

#### Home

- Home automation
- Smart TV
- OTT box
- Smart speaker
- Smart home appliances





### Others

- Wireless POS
- IP camera
- ATM

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# The number one cellular module vendor in the world and a leading GNSS module supplier

- Unbeatable choice from the broadest module portfolio in the world
- The highest quality products for the best possible prices
- Superb support with the largest R&D team in the industry
- Continuous innovation first to market with 5G, LPWA, CV2X, snapdragon
- A passionate, dedicated team of "Quectelers" ensure our customers always come first

Thankyou

Build a Smarter World

